501830360 02/23/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Takanobu TAKEDA	02/13/2012
Kyoko SOGA	02/13/2012
Satoshi ASAI	02/13/2012

RECEIVING PARTY DATA

Name:	Shin-Etsu Chemical Co., Ltd.	
Street Address:	6-1, Ohtemachi 2-chome, Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13401940

CORRESPONDENCE DATA

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NAME OF SUBMITTER: Gerald M. Murphy, Jr.

Total Attachments: 2

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PATENT

REEL: 027752 FRAME: 0865

BIRCH, STEWART, KOLASCH & BIRCH, LLP

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UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No.	13/401,940 F	iled	2-22-12		
Insert Name(s) of Inventor(s)	***(Given Name FAMILY NAME (ALL CAPS))***				
	WHEREAS, Takanobu TAKEDA, Kyoko SOGA and (hereinafter designated as the undersigned) has (have) inv				
Insert Title of Invention	Adhesive Composition and Adhesive Dry Film	m			
	for which an application for Letters Patent of the Unundersigned (except in the case of a provisional application)		s of America has been executed by the		
Insert Date of Signing of Application Insert Name of Assignee Insert Address of Assignee	on <u>February 13, 2012</u> ; a	nd			
	WHEREAS, Shin-Etsu Chemical Co., Ltd.				
	of 6-1, Ohtemachi 2-chome, Chiyoda-ku, Tokyo, Ja	<u>pan</u>			
CHECK BOX IF APPROPRIATE	its heirs, successors, legal representatives and assign desirous of acquiring the entire right, title and interest Patent(s) that may be granted therefor in the United State in any foreign countries.	in and to	said invention and in and to any Letters		
	NOW, THEREFORE, in consideration of the sum of paid, the receipt of which is hereby acknowledged, undersigned has (have) sold, assigned and transferre transfer unto said Assignee the full and exclusive rig America, its territories, dependencies and possessions any and all Letters Patent(s) which may be granted territories, dependencies and possessions, and if the countries;	and other and be the to the sand the therefore	r good and valuable consideration, the by these presents does sell, assign and said invention in the United States of entire right, title and interest in and to in the United States of America, its		
	and to any and all divisions, reissues, continuations, term or terms for which the same may be granted.	conversi	ons and extensions thereof for the full		

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date _	February 13, 2012,	Name of Inventor Jakanobec Jakeda
		(signature) Takanobu TAKEDA
Date _	February 13, 2012,	Name of Inventor Kyoko Soza
		(signature) kyoko SOGA
Date _	February 13, 2012,	Name of Inventor Satoshi Asm
		(signature) Satoshi ASAI
Date _	· · · · · · · · · · · · · · · · · · ·	Name of Inventor
		(signature)

RECORDED: 02/23/2012